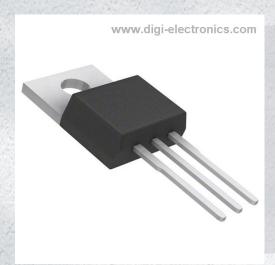


FCP16N60 Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number FCP16N60-DG

Manufacturer onsemi

Manufacturer Product Number FCP16N60

Description MOSFET N-CH 600V 16A TO220-3

Detailed Description N-Channel 600 V 16A (Tc) 167W (Tc) Through Hole

TO-220-3



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FCP16N60	onsemi
Series:	Product Status:
SuperFET™	Not For New Designs
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
600 V	16A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	260mOhm @ 8A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
5V @ 250μA	70 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±30V	2250 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	167W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
TO-220-3	TO-220-3
Base Product Number:	
FCP16	

Environmental & Export classification

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

1



MOSFET - N-Channel, **SUPERFET®**

600 V, 16 A, 260 mΩ

FCP16N60, FCPF16N60

Description

SUPERFET MOSFET is onsemi's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications.

Features

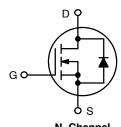
- $R_{DS(on)} = 220 \text{ m}\Omega \text{ (Typ.)}$
- Ultra Low Gate Charge (Typ. Q_g = 55 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 110 pF)
- 100% Avalanche Tested
- These are Pb-Free Devices

Applications

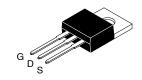
- Solar Inverter
- AC-DC Power Supply

V _{DS}	R _{DS(on)} MAX	I _D MAX
600 V	260 mΩ @ 10 V	16 A*

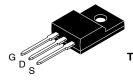
^{*}Drain current limited by maximum junction temperature.



N-Channel

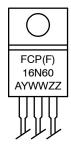


TO-220-3LD CASE 340AT



TO-220 Fullpack, 3-Lead /TO-220F-3SG CASE 221AT

MARKING DIAGRAM



FCP(F)16N60 = Specific Device Code = Assembly Location YWW = Date Code (Year & Week)

ZZ = Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
FCP16N60	TO-220-3	1000 Units / Tube
FCPF16N60	TO-220-3 FullPak	1000 Units / Tube

MOSFET MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter		FCP16N60	FCPF16N60	Unit
V _{DSS}	Drain-Source Voltage		600		V
I _D	Drain Current	– Continuous (T _C = 25°C)	16	16*	А
		– Continuous (T _C = 100°C)	10.1	10.1*	
I _{DM}	Drain Current	- Pulsed (Note 1)	48	48*	А
V _{GSS}	Gate-Source Voltage	•	±30		V
E _{AS}	Single Pulsed Avalance	he Energy (Note 2)	450		mJ
I _{AR}	Avalanche Current (No	ote 1)	16		Α
E _{AR}	Repetitive Avalanche E	Energy (Note 1)	20.8		mJ
dv/dt	Peak Diode Recovery	dv/dt (Note 3)	4	1.5	V/ns
P_{D}	Power Dissipation	(T _C = 25°C)	167	37.9	W
		– Derate Above 25°C	1.33	0.3	W/°C
T _J , T _{STG}	Operating and Storage	Temperature Range	-55 to +150		°C
TL	Maximum Lead Tempe 1/8" from Case for 5 Se		300		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality stresses exceeding those listed in the Maximum Hatings table may damage it should not be assumed, damage may occur and reliability may be affected. *Drain current limited by maximum junction temperature.
1. Repetitive rating: pulse–width limited by maximum junction temperature.
2. $I_{AS} = 8 \text{ A}$, $V_{DD} = 50 \text{ V}$, $R_G = 25 \Omega$, starting $T_J = 25 ^{\circ}\text{C}$.
3. $I_{SD} \le 16 \text{ A}$, $I_{SD} \le$

THERMAL CHARACTERISTICS

Symbol	Parameter	FCP16N60	FCPF16N60	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	0.75	3.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS				-	-
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V, T_J = 25^{\circ}C$	600	-	_	V
		$I_D = 250 \mu A, V_{GS} = 0 V, T_J = 150 ^{\circ} C$	-	650	_	V
ΔBV_{DSS}	Breakdown Voltage Temperature	I _D = 250 μA, Referenced to 25°C	-	0.6	-	V/°C
ΔT_{J}	Coefficient					
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	V _{GS} = 0 V, I _D = 16 A	-	700	=	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600 V, V _{GS} = 0 V	-	-	1	μΑ
		V _{DS} = 480 V, T _C = 125°C	-	-	10	
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±30 V, V _{DS} = 0 V	-	-	±100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	3.0	-	5.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 8 A	-	0.22	0.26	Ω
9FS	Forward Transconductance	V _{DS} = 40 V, I _D = 8 A	-	11.5	_	S
DYNAMIC (CHARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	-	1730	2250	pF
C _{oss}	Output Capacitance]	-	960	1150	pF
C _{rss}	Reverse Transfer Capacitance]	-	85	-	pF
C _{oss}	Output Capacitance	V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz	-	45	60	pF
C _{oss(eff.)}	Effective Output Capacitance	V _{DS} = 0 V to 400 V, V _{GS} = 0 V	-	110	-	pF
Q_g	Total Gate Charge at 10 V	$V_{DS} = 480 \text{ V}, I_D = 16 \text{ A}, V_{GS} = 10 \text{ V}$	-	55	70	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	10.5	13	nC
Q _{gd}	Gate to Drain "Miller" Charge]	-	28	=	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	1.7	-	Ω
SWITCHING	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 300 V, I _D = 16 A, V _{GS} = 10 V,	-	42	85	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$ (Note 4)	-	130	270	ns
t _{d(off)}	Turn-Off Delay Time]	-	165	340	ns
t _f	Turn-Off Fall Time]	-	90	190	ns
DRAIN-SO	URCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS				
Is	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	16	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	48	Α
V _{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 16 A	-	-	1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 16 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	435	-	ns
Q _{rr}	Reverse Recovery Charge	GS 1, 13D 1111, 1117, 1117	_	7.0	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

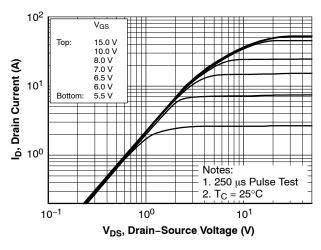


Figure 1. On-Region Characteristics

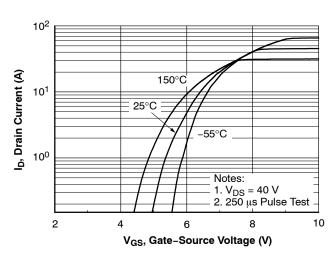


Figure 2. Transfer Characteristics

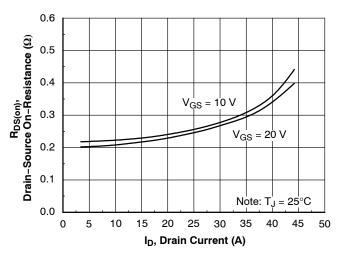


Figure 3. On-Resistance Variation vs. Drain Current and Gate voltage

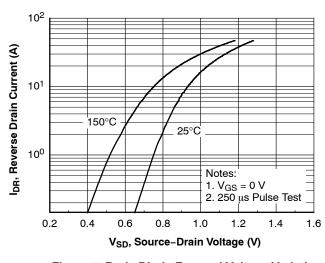


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

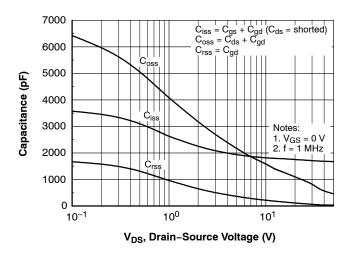


Figure 5. Capacitance Characteristics

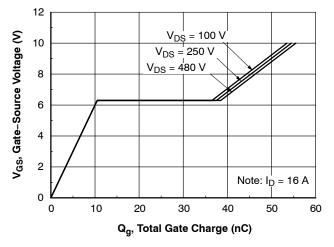
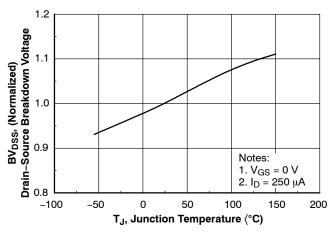


Figure 6. Gate Charge Characteristics

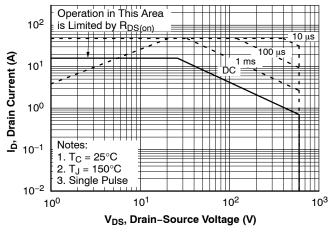
TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



3.0 R_{DS(on)}, (Normalized) Drain-Source On-Resistance 2.5 2.0 1.5 1.0 Notes: 0.5 1. $V_{GS} = 10 \text{ V}$ 2. I_D = 8 A 0.0 -100 -50 0 150 200 50 100 T_J, Junction Temperature (°C)

Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



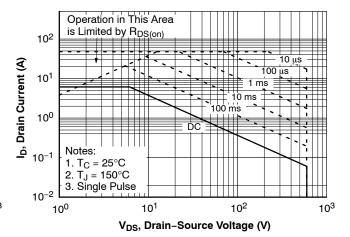


Figure 9. Maximum Safe Operating Area for FCP16N60

Figure 10. Maximum Safe Operating Area for FCPF16N60

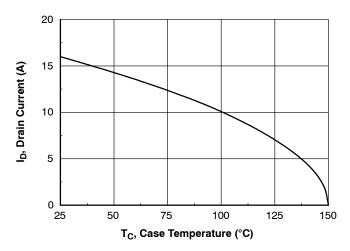


Figure 11. Maximum Drain Current vs. Case Temperature

+

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

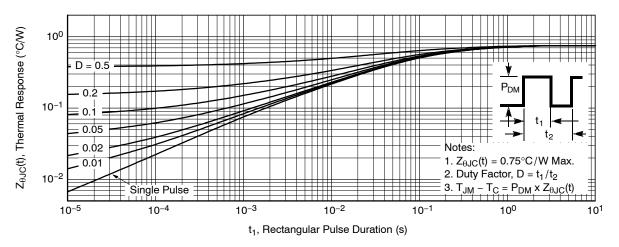


Figure 12. Transient Thermal Response Curve for FCP16N60

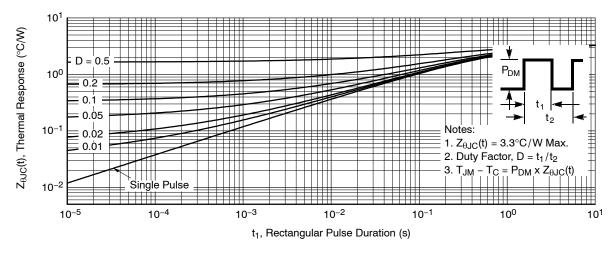


Figure 13. Transient Thermal Response Curve for FCPF16N60

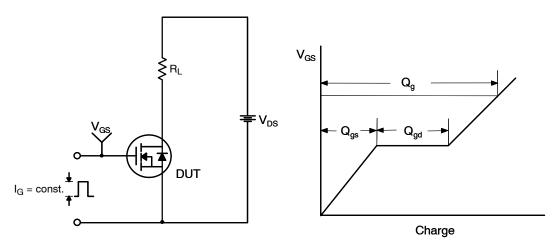


Figure 14. Gate Charge Test Circuit & Waveform

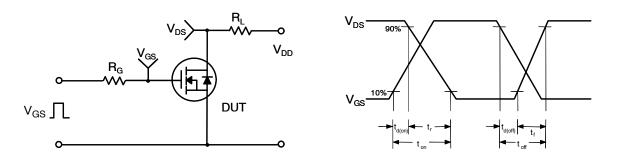


Figure 15. Resistive Switching Test Circuit & Waveforms

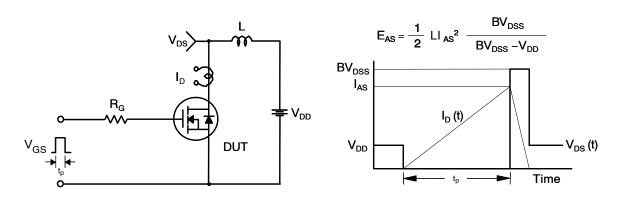
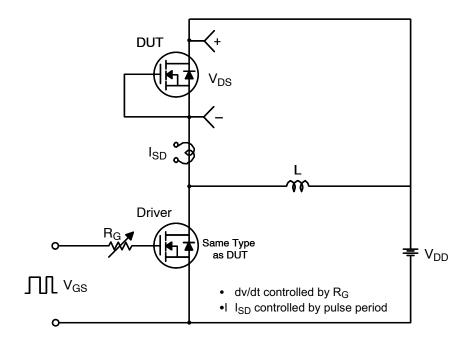


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms



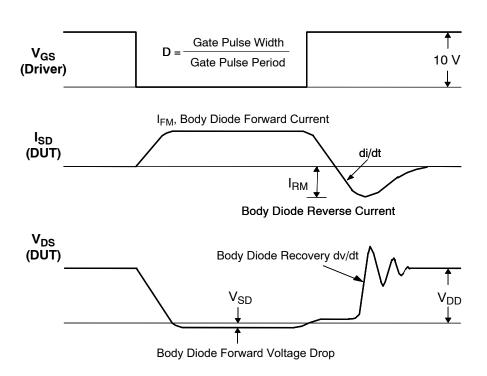


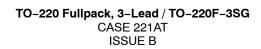
Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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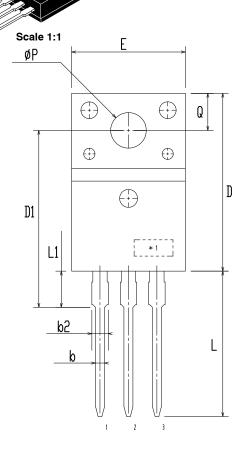


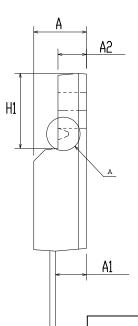
MECHANICAL CASE OUTLINE

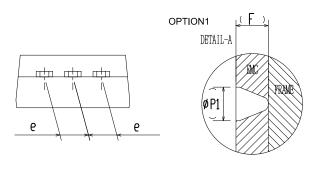
PACKAGE DIMENSIONS



DATE 19 JAN 2021







DIM	MIL	LIMITERS	
DIM	MIN	NDM	MAX
Α	4.50	4.70	4.90
A1	2.56	2.76	2.96
A2	2.34	2.54	2.74
b	0.70	0.80	0.90
b2	~	~	1.47
С	0.45	0.50	0.60
D	15.67	15.87	16.07
D1	15.60	15.80	16.00
E	9,96	10.16	10.36
е	2.34	2.54	2.74
F	~	0.84	~
H1	6.48	6.68	6.88
L	12.78	12.98	13.18
L1	3.03	3.23	3.43
ØΡ	2.98	3.18	3.38
Ø P1	~	1.00	~
Q	3.20	3.30	3.40

NOTES:

- A. DIMENSION AND TOLERANCE AS ASME Y14.5-2009
- B. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUCSIONS.
- C. OPTION 1 WITH SUPPORT PIN HOLE OPTION 2 NO SUPPORT PIN HOLE

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DESCRIPTION:	TO-220 FULLPACK, 3-LEAD / TO-220F-3SG		PAGE 1 OF 1	

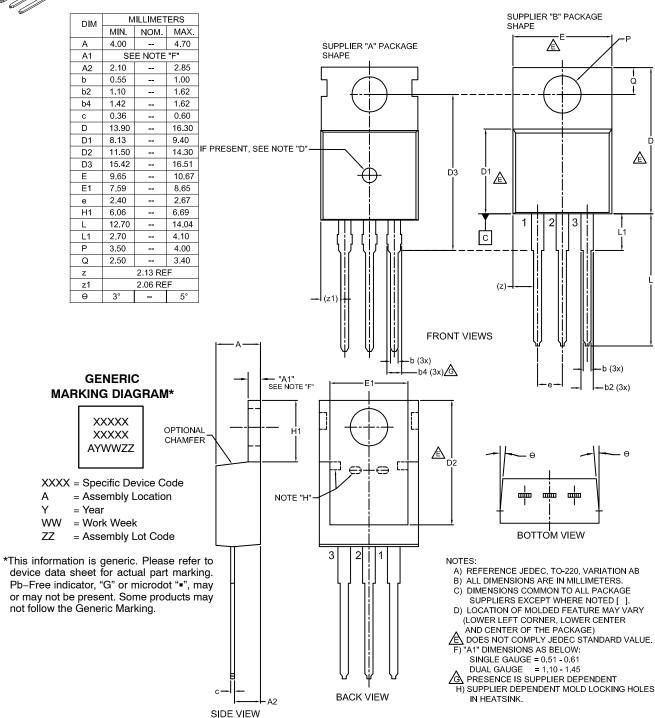
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

TO-220-3LD CASE 340AT ISSUE B

DATE 08 AUG 2022



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